# Introduction to Embedded Systems and Applications

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## Intro: Tassadaq Hussain

#### **Research Areas:**

- High Performance Computing
- Digital System Design
- Machine Learning
- Heterogeneous Computing, based on
  - FPGAs, GPUs and Microprocessors
- Real-time Embedded Vision

#### **Professional Affiliations**

- HiPEAC: European Network on High Performance and Embedded Architecture and Compilation
- Barcelona Supercomputing Center Spain
- Université de Valenciennes France
- Centre or Chiropractic Research New Zeland

PhD – UPC BarcelonaTech Spain MS (Digital System Design) – ISEP Paris France

#### **Projects**

- 1) Design, Development And Production Of Hardware Based Gel Documentation System For Dna, Rna And Protiens Analysis
- 2) Development of Scalable Heterogeneous Super-computing System
- Low Power Low Cost Supercomputer Architecture for Undeveloped Countries. 2016 UCERD and BlueSurge Pvt Ltd 2.5 Million
- 4) FPGA Powered Supercomputer System Riphah and UCERD
- 5) Iris based Disease Diagnosis System (NRPU-18) 2.52 Million Rs.
- 6) Design Ultra Low Cost Display Camera Interface for Mobile Baseband XGold Chip at Infineon Technologies France.
- 7) Implementation of Reverse Time Migration on FGPAs at PLDA

### Research Grants: (0.6 Million US \$)

- HEC NRPU 1
- Technology Development Fund (2)
- Publications: (I.F. 20.2)
  - Referred Top Conferences: 35
  - Book Chapter: 2
  - Journal 15
- Patent: 10

### Industrial Experience: (Above 14 Years)

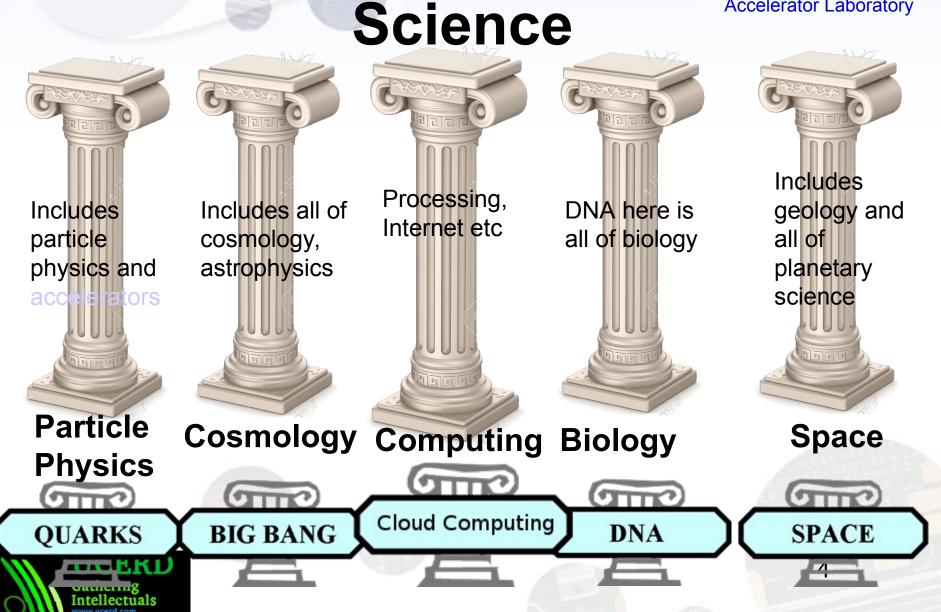


# Outline

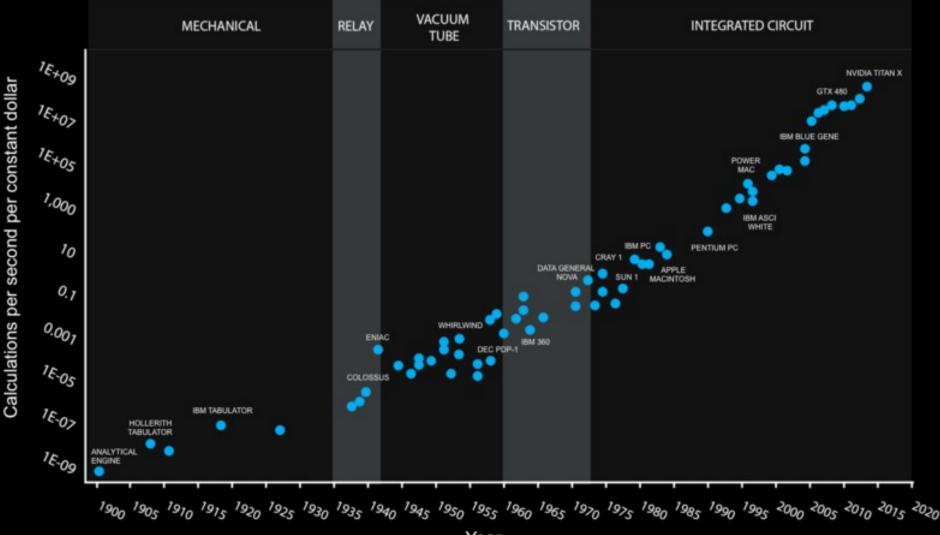
- Importance of Computing
- Embedded systems overview
- Design Flow
- Ecosystem
  - System Architecture
  - Compiler
  - Programming Enviroment
- Marketing Strategy
  - Competetors
  - SWOT
  - Financial Factor
- Design challenge

### **Pillars of Science**

Fermi National Accelerator Laboratory



## 120 Years of Moore's Law



# Embedded systems overview

Computing systems are everywhere Most of us think of "desktop" computers

- PC's
- Laptops
- Mainframes
- Servers
- Cluster
- Supercomptuers

# Embedded systems overview

- Embedded computing systems
- Computing systems embedded within electronic devices
- Hard to define. Nearly any computing system other than a desktop computer
- Billions of units produced yearly, versus millions of desktop units
- Perhaps 50 per household and per automobile

Computers are in here	
and here	

and even here...







Lots more of these, though they cost a lot less each.

# A "short list" of embedded systems

Anti-lock brakes Auto-focus cameras Automatic teller machines Automatic toll systems Automatic transmission Avionic systems Battery chargers Camcorders Cell phones Cell-phone base stations Cordless phones Cruise control Curbside check-in systems Digital cameras Disk drives Electronic card readers Electronic instruments Electronic toys/games Factory control Fax machines **Fingerprint identifiers** Home security systems Life-support systems Medical testing systems

Modems MPEG decoders Network cards Network switches/routers On-board navigation Pagers Photocopiers Point-of-sale systems Portable video games Printers Satellite phones Scanners Smart ovens/dishwashers Speech recognizers Stereo systems Teleconferencing systems Televisions Temperature controllers Theft tracking systems TV set-top boxes VCR's, DVD players Video game consoles Video phones Washers and dryers

















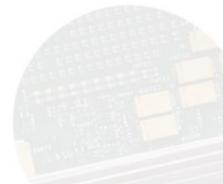




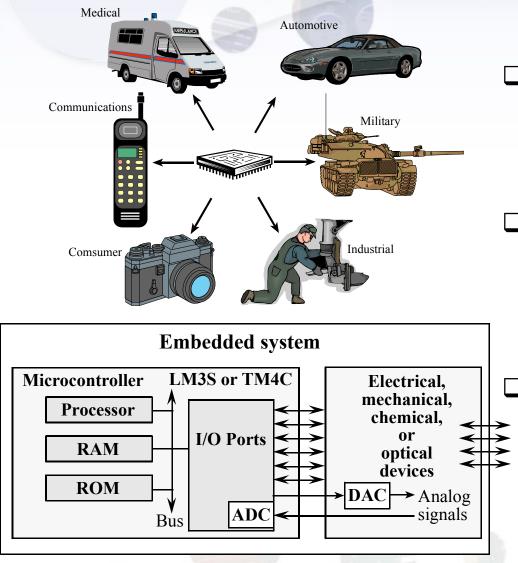




And the list goes on and on



# **Embedded System**



- Embedded Systems are everywhere
  - Ubiquitous, invisible
  - Hidden (computer inside)
  - Dedicated purpose
- □ Microprocessor
  - Intel: 4004, ..8080,.. x86
  - Freescale: 6800, .. 9S12,... PowerPC
  - ARM, DEC, SPARC, MIPS, PowerPC, Natl. Semi.,...
  - Microcontroller
    - Processor+Memory+
       I/O Ports (Interfaces)

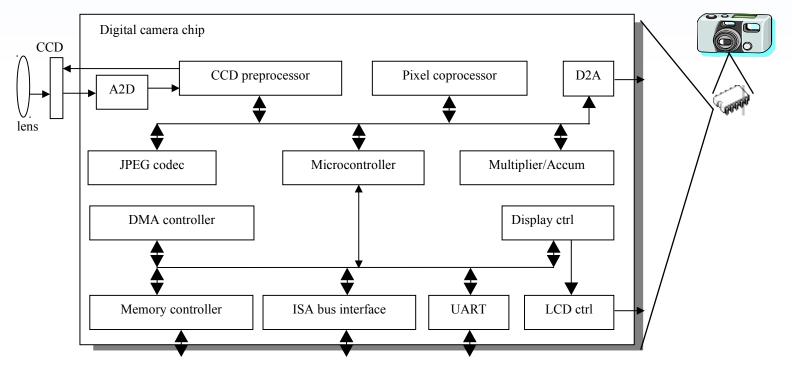
# Microcontroller

- Processor Instruction Set + memory + accelerators
  - Ecosystem
- Memory
  - Non-Volatile
    - o ROM
    - o EPROM, EEPROM, Flash
  - Volatile
    - o RAM (DRAM, SRAM)
- Interfaces
  - ✤ H/W: Ports
  - S/W: Device Driver
  - Parallel, Serial, Analog, Time
- - Memory-mapped vs. I/O-instructions (I/O-mapped)

# Some common characteristics of embedded systems

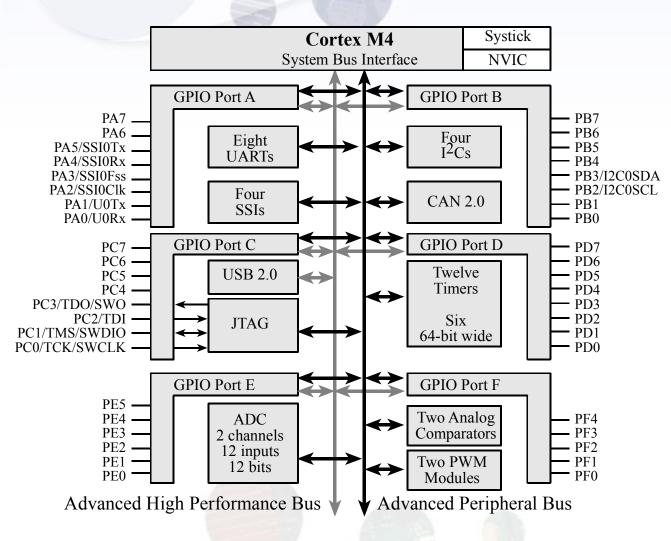
- Single-functioned
- Executes a single program, repeatedly
- Tightly-constrained
- Low cost, low power, small, fast, etc.
- Reactive and real-time
- Continually reacts to changes in the system's environment
- Must compute certain results in real-time without delay

# An embedded system example -a digital camera



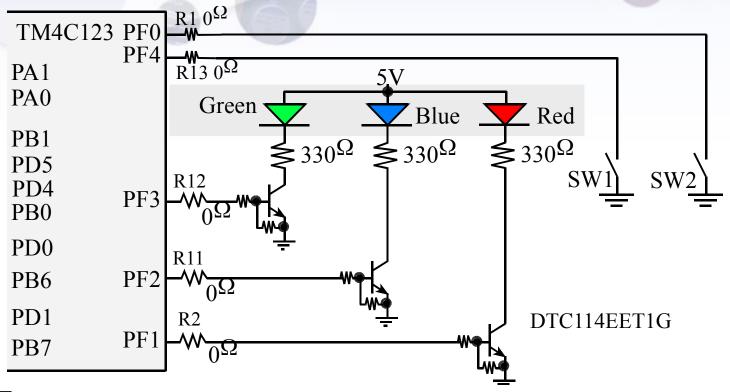
- Single-functioned -- always a digital camera
- Tightly-constrained -- Low cost, low power, small, fast
- Reactive and real-time -- only to a small extent

# **Texas Instruments TM4C123**



ARM Cortex-M4 + 256K EEPROM + 32K RAM + JTAG + JTAG + Ports + SysTick + ADC + UART

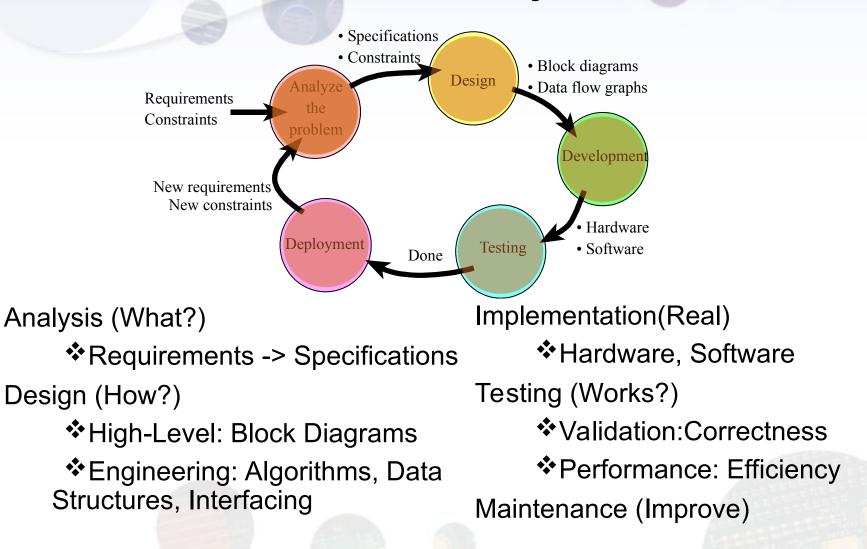
## LaunchPad Switches and LEDs



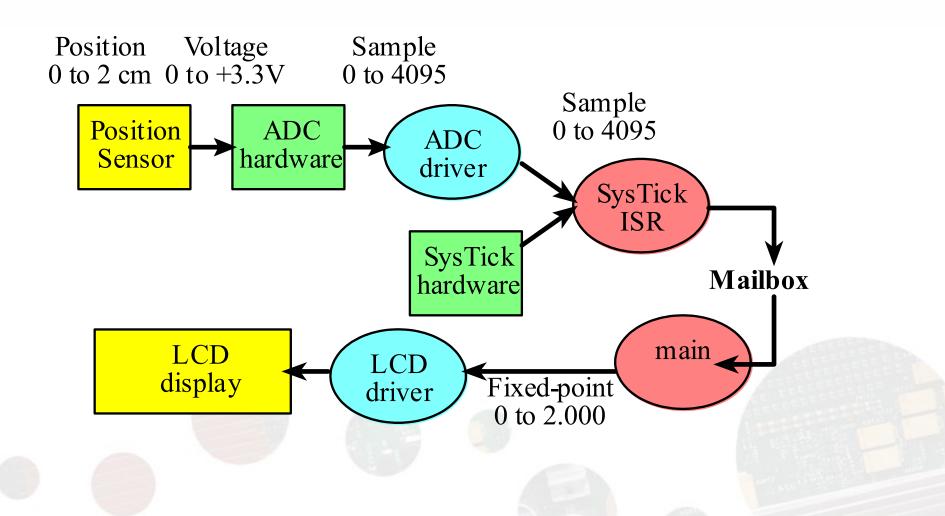
The switches on the LaunchPad
\*Negative logic

\*Require internal pull-up (set bits in PUR) The PF3-1 LEDs are positive logic

## **Product Life Cycle**

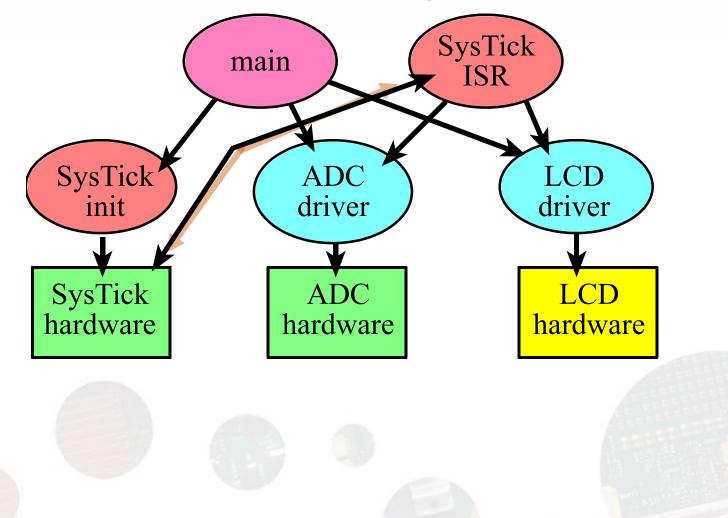


## **Data Flow Graph**



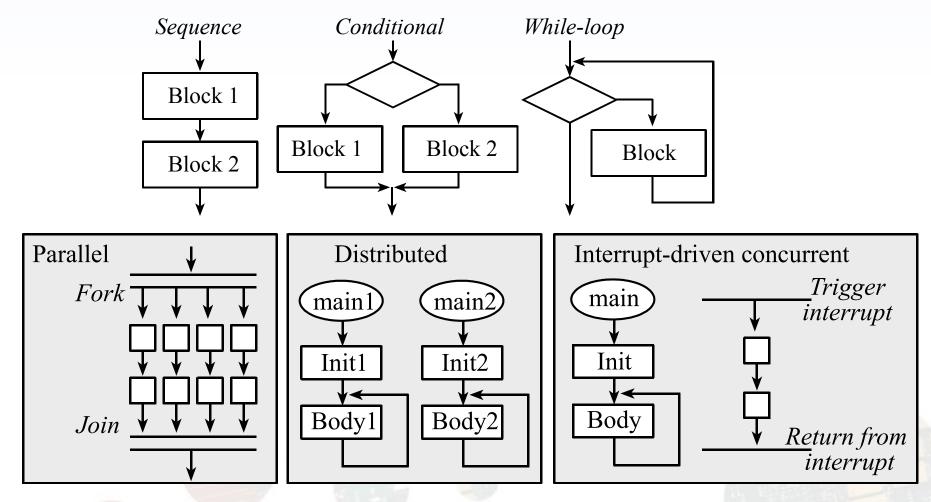
## **Call Flow Graph**

**Position Measurement System** 



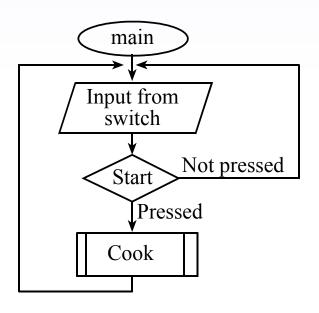
# Structured Programming

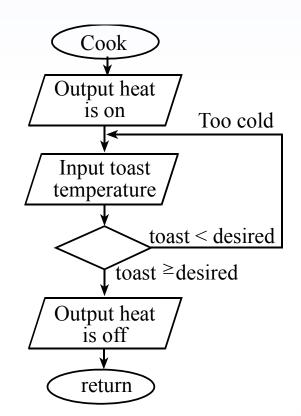
#### Common Constructs (as Flowcharts)



## Flowchart

### Toaster oven:





Coding in assembly and/or high-level language (C)

## **Processor Architectures**

**ISA: Instruction Set Architecture** 

- ARM: Low Power Low Cost
- x86: High Performance
- High-Performance x86 and ARM
- Industry-Leading & Most Efficient GPUs<sup>1,2</sup>
- Scalable Designs
- Memory Innovation
- Open Approach







## ARM Cortex M4-based System

#### □ RISC machine

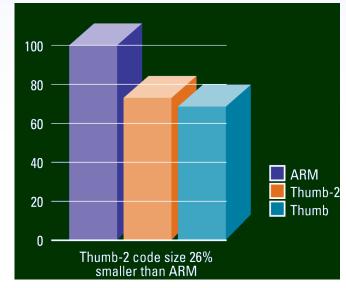
- \* *Pipelining* effectively provides single cycle operation for many instructions
- Thumb-2 configuration employs both 16 and 32 bit instructions

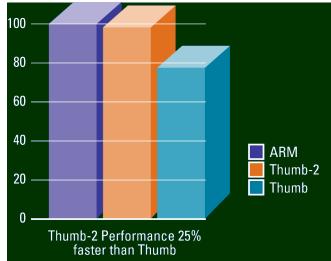
CISC	RISC
Many instructions	Few instructions
Instructions have varying lengths	Instructions have fixed lengths
Instructions execute in varying times	Instructions execute in 1 or 2 bus cycles
Many instructions can access memory	Few instructions can access memory
	• Load from memory to a register
	Store from register to memory
In one instruction, the processor can both	No one instruction can both read and write
• read memory and	memory in the same instruction
• write memory	
Fewer and more specialized registers.	Many identical general purpose registers
• some registers contain data,	
• others contain addresses	
Many different types of addressing modes	Limited number of addressing modes
	• register,
	• immediate, and
	• indexed.

## **ARM ISA: Thumb2 Instruction Set**

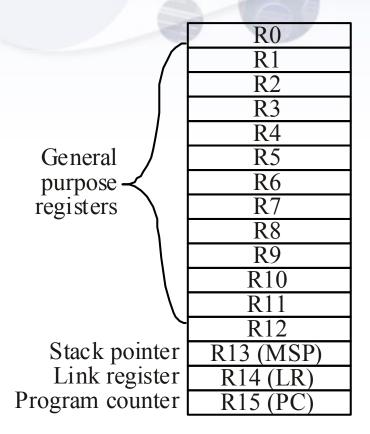
### Variable-length instructions

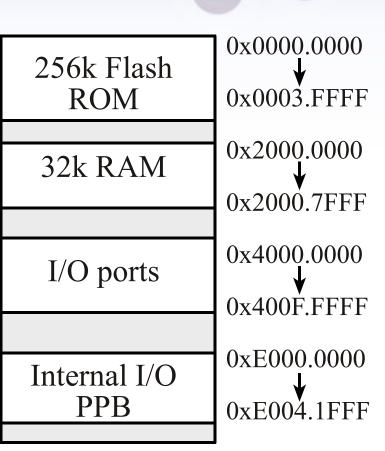
- ARM instructions are a fixed length of 32 bits
- Thumb instructions are a fixed length of 16 bits
- Thumb-2 instructions can be either 16-bit or 32-bit
- Thumb-2 gives approximately 26% improvement in code density over ARM
- Thumb-2 gives approximately 25% improvement in performance over Thumb





## ARM ISA: Registers, Memory-map





#### **Condition Code Bits**

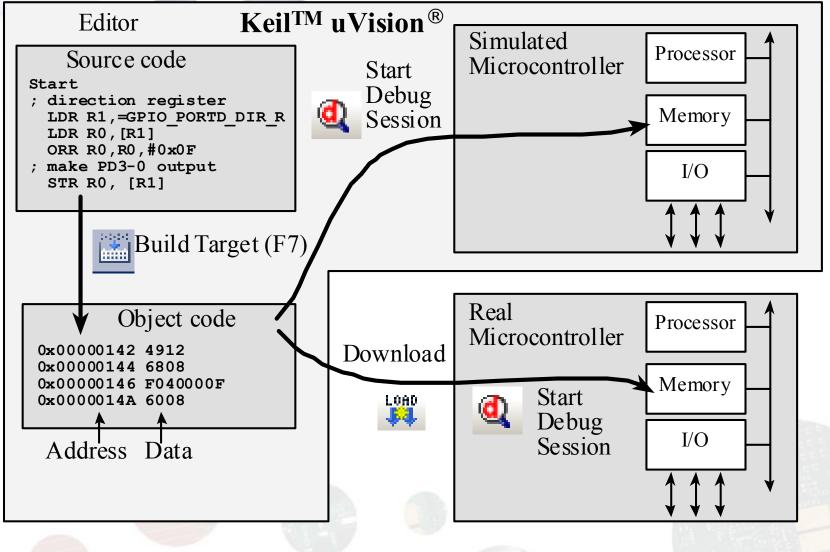
#### <u>Indicates</u>

N negativeZ zeroV overflow

C carry

Result is negative Result is zero Signed overflow Unsigned overflow TI TM4C123 Microcontroller

# SW Development Environment



# Design challenge – optimizing design metrics

Obvious design goal:

Construct an implementation with desired functionality

Key design challenge:

Simultaneously optimize numerous design metrics

## Design metric

A measurable feature of a system's implementation Optimizing design metrics is a key challenge

# Design challenge – optimizing design metrics

## **Common metrics**

**Unit cost:** the monetary cost of manufacturing each copy of the system, excluding NRE cost

NRE cost (Non-Recurring Engineering cost): The onetime monetary cost of designing the system

Size: the physical space required by the system

**Performance:** the execution time or throughput of the system

**Power:** the amount of power consumed by the system

Flexibility: the ability to change the functionality of the system without incurring heavy NRE cost

# Design challenge – optimizing design metrics

## Common metrics (continued)

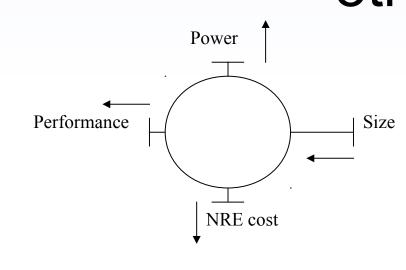
Time-to-prototype: the time needed to build a working version of the system

**Time-to-market:** the time required to develop a system to the point that it can be released and sold to customers

Maintainability: the ability to modify the system after its initial release

Correctness, safety, many more

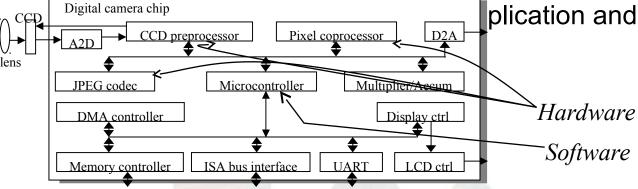
## Design metric competition improving one may worsen others



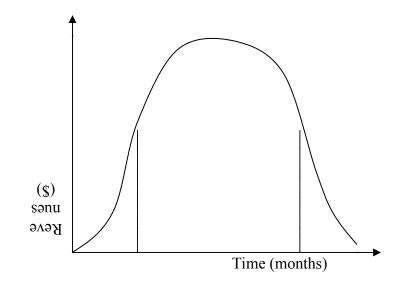
Expertise with both **software** and hardware is needed to optimize design metrics Not just a hardware or software expert, as is common

A designer must be comfortable with various technologies in order to choose the best for a given

plication and constraints



# Time-to-market: a demanding design metric



Time required to develop a product to the point it can be sold to customers

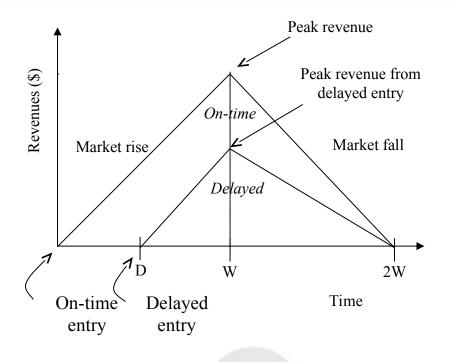
### Market window

Period during which the product would have highest sales

Average time-to-market constraint is about 8 months Delays can be costly



# Losses due to delayed market entry

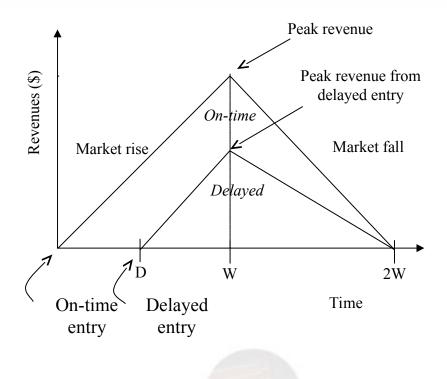


Simplified revenue model Product life = 2W, peak at W Time of market entry defines a triangle, representing market penetration Triangle area equals revenue

#### Loss

The difference between the ontime and delayed triangle areas

# Losses due to delayed market entry (cont.)



Area = 1/2 \* base \* height On-time = 1/2 \* 2W \* W Delayed = 1/2 \* (W-D+W)\*(W-D) Percentage revenue loss =  $(D(3W-D)/2W^2)$ \*100% Try some examples

- Lifetime 2W=52 wks, delay D=4 wks
- $(4*(3*26-4)/2*26^2) = 22\%$
- Lifetime 2W=52 wks, delay D=10 wks
- $(10^*(3^*26 10)/2^*26^2) = 50\%$
- Delays are costly!

## NRE and unit cost metrics

#### Costs:

Unit cost: the monetary cost of manufacturing each copy of the system, excluding NRE cost

NRE cost (Non-Recurring Engineering cost): The one-time monetary cost of designing the system

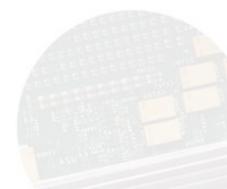
total cost = NRE cost + unit cost \* # of units

per-product cost = total cost / # of units

= (NRE cost / # of units) + unit cost

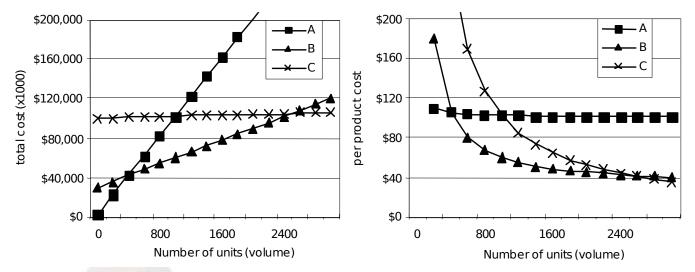
- Example
  - NRE=\$2000, unit=\$100
  - For 10 units
    - total cost =  $2000 + 10 \times 100 = 3000$
    - per-product  $\cos t = \frac{2000}{10} + 100 = 300$

Amortizing NRE cost over the units results in an additional \$200 per unit



## NRE and unit cost metrics

Compare technologies by costs -- best depends on quantity Technology A: NRE=\$2,000, unit=\$100 Technology B: NRE=\$30,000, unit=\$30 Technology C: NRE=\$100,000, unit=\$2



• But, must also consider time-to-market

# The performance design metric

## Widely-used measure of system, widely-abused

Clock frequency, instructions per second – not good measures Digital camera example – a user cares about how fast it processes images, not clock speed or instructions per second

## Latency (response time)

Time between task start and end

e.g., Camera's A and B process images in 0.25 seconds

## Throughput

Tasks per second, e.g. Camera A processes 4 images per second

Throughput can be more than latency seems to imply due to concurrency, e.g. Camera B may process 8 images per second (by capturing a new image while previous image is being stored).

### Speedup of B over S = B's performance / A's performance Throughput speedup = 8/4 = 2

# Three key embedded system technologies

## Technology

A manner of accomplishing a task, especially using technical processes, methods, or knowledge

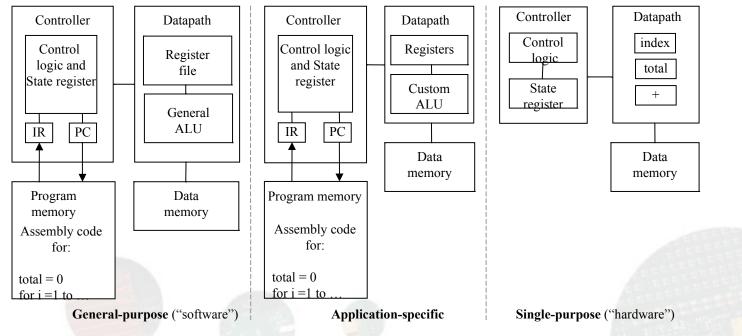
- Three key technologies for embedded systems
- **Processor technology**
- IC technology
- **Design technology**

## **Processor technology**

The architecture of the computation engine used to implement a system's desired functionality

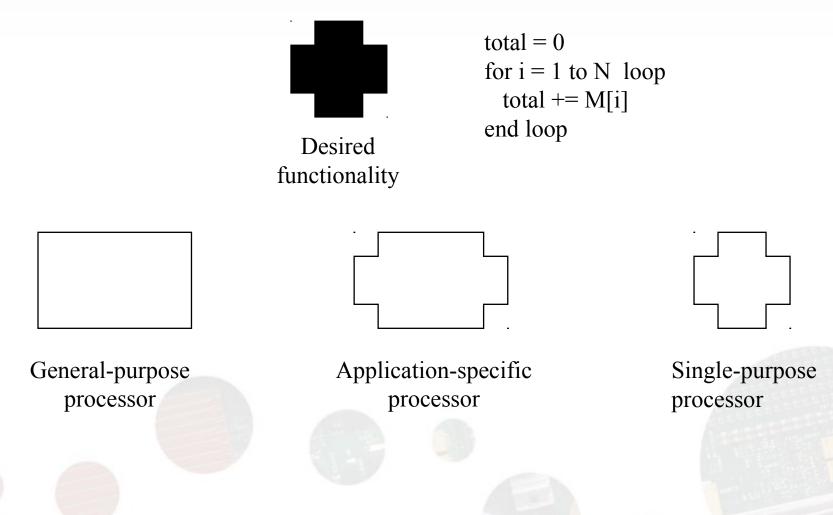
Processor does not have to be programmable

"Processor" *not* equal to general-purpose processor



## **Processor technology**

Processors vary in their customization for the problem at hand



#### General-purpose processors

Programmable device used in a variety of applications

Also known as "microprocessor"

Features

Program memory

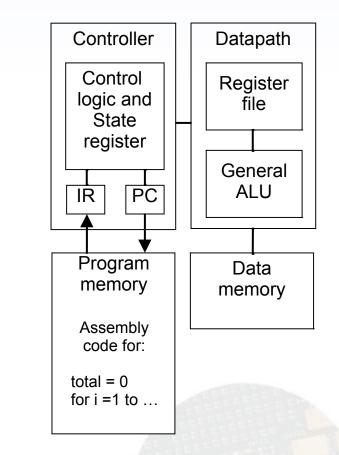
General datapath with large register file and general ALU

User benefits

Low time-to-market and NRE costs

High flexibility

"Pentium" the most well-known, but there are hundreds of others



#### Single-purpose processors

Digital circuit designed to execute exactly one program

a.k.a. coprocessor, accelerator or peripheral

#### Features

Contains only the components needed to execute a single program

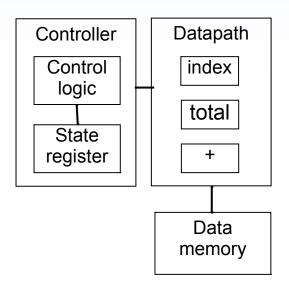
No program memory

Benefits

Fast

Low power

Small size



#### **Application-specific processors**

Programmable processor optimized for a particular class of applications having common characteristics

Compromise between general-purpose and single-purpose processors

#### Features

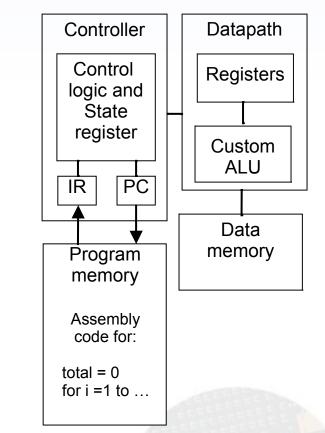
Program memory

Optimized datapath

Special functional units

Benefits

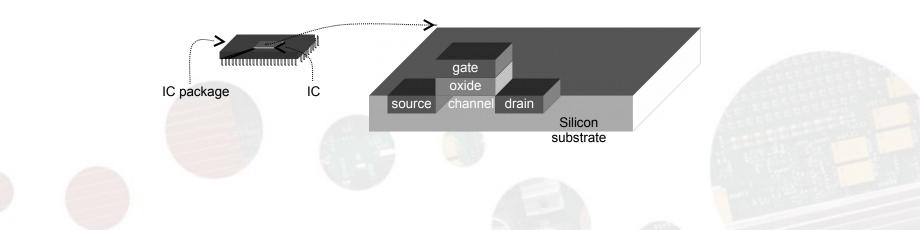
Some flexibility, good performance, size and power



## IC technology

The manner in which a digital (gate-level) implementation is mapped onto an IC

- IC: Integrated circuit, or "chip"
- IC technologies differ in their customization to a design IC's consist of numerous layers (perhaps 10 or more)
  - IC technologies differ with respect to who builds each layer and when



#### IC technology

Three types of IC technologies Full-custom/VLSI Semi-custom ASIC (gate array and standard cell) PLD (Programmable Logic Device)



## Full-custom/VLSI

All layers are optimized for an embedded system's particular digital implementation **Placing transistors** Sizing transistors **Routing wires Benefits** Excellent performance, small size, low power **Drawbacks** High NRE cost (e.g., \$300k), long time-to-market

#### Semi-custom

Lower layers are fully or partially built

Designers are left with routing of wires and maybe placing some blocks

#### Benefits

Good performance, good size, less NRE cost than a full-custom implementation (perhaps \$10k to \$100k)

#### Drawbacks

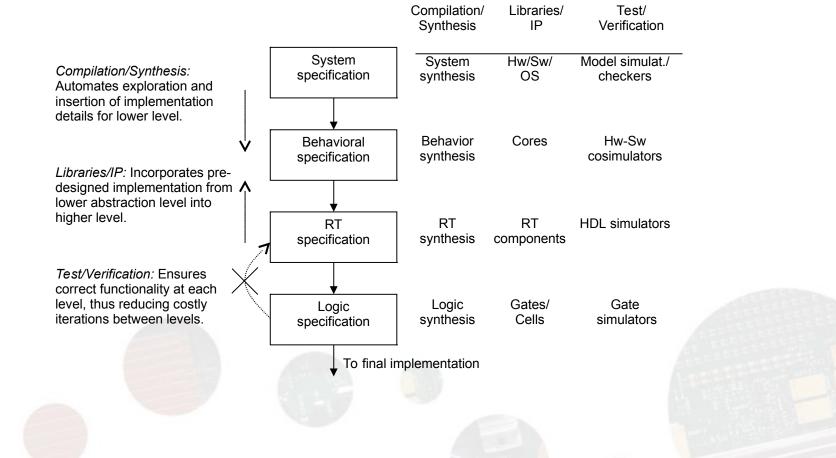
Still require weeks to months to develop

# PLD (Programmable Logic Device)

- All layers already exist
- Designers can purchase an IC
- Connections on the IC are either created or destroyed to implement desired functionality
- Field-Programmable Gate Array (FPGA) very popular
- Benefits
- Low NRE costs, almost instant IC availability
- Drawbacks
- Bigger, expensive (perhaps \$30 per unit), power hungry, slower

## **Design Technology**

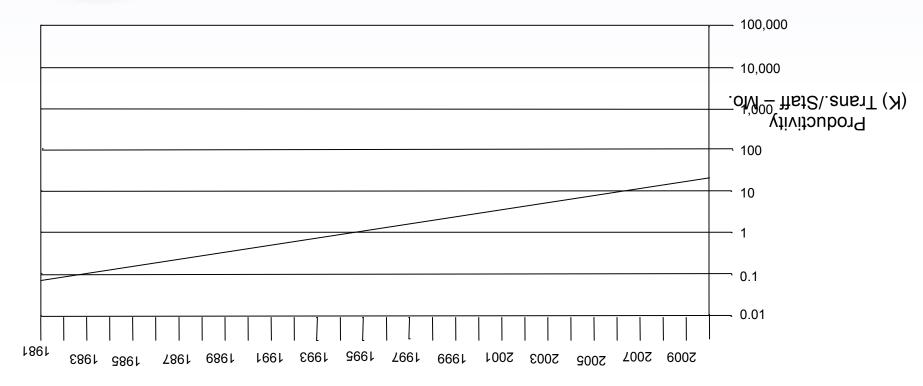
## The manner in which we convert our concept of desired system functionality into an implementation



## **Financial Factor**

- Actual investment
- Compound Annual Growth Rate
- Average Product Price
- ROI
- IRR
- Payback Period

## Design productivity exponential increase



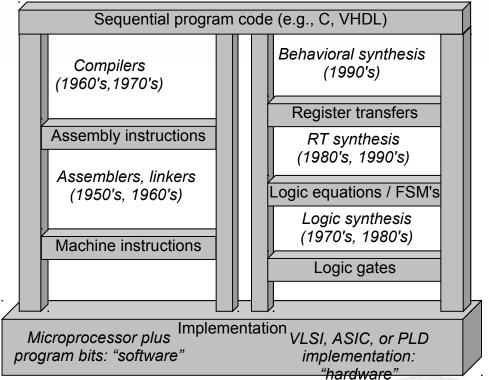
Exponential increase over the past few decades

## The co-design ladder

#### In the past:

Hardware and software design technologies were very different Recent maturation of synthesis enables a unified view of hardware and software

Hardware/software "codesign"



The choice of hardware versus software for a particular function is simply a tradeoff among various design metrics, like performance, power, size, NRE cost, and especially flexibility; there is no fundamental difference between what hardware or software can implement.

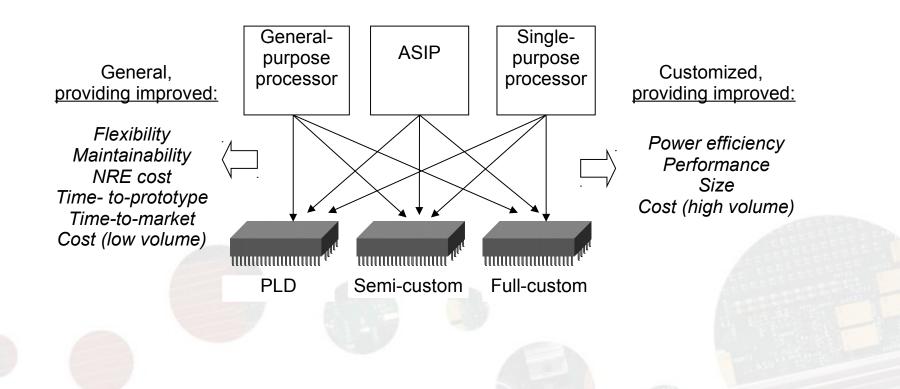
## Independence of processor and IC technologies

#### **Basic tradeoff**

General vs. custom

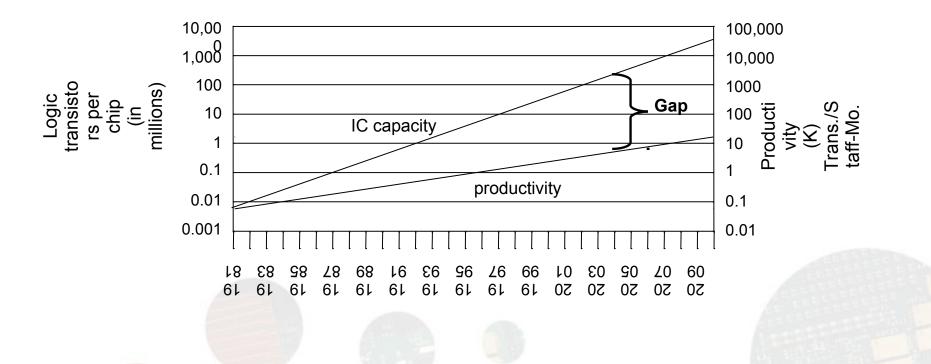
With respect to processor technology or IC technology

The two technologies are independent



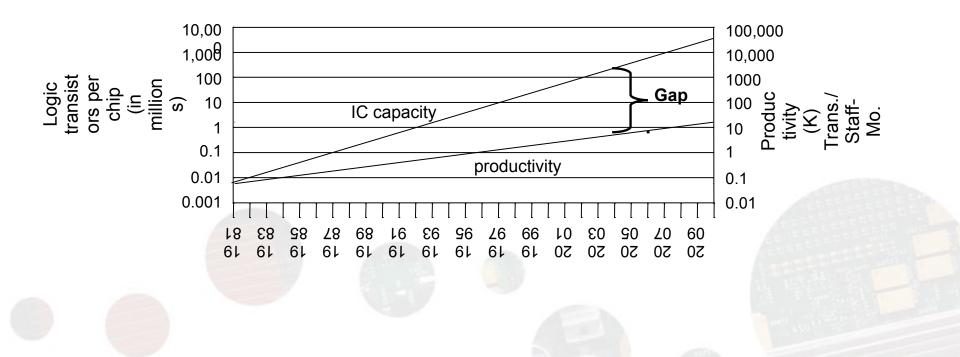
#### Design productivity gap

While designer productivity has grown at an impressive rate over the past decades, the rate of improvement has not kept pace with chip capacity



#### Design productivity gap

1981 leading edge chip required 100 designer months
10,000 transistors / 100 transistors/month
2002 leading edge chip requires 30,000 designer months
150,000,000 / 5000 transistors/month
Designer cost increase from \$1M to \$300M



#### Summary

Embedded systems are everywhere

Key challenge: optimization of design metrics

Design metrics compete with one another

- A unified view of hardware and software is necessary to improve productivity
- Three key technologies

Processor: general-purpose, application-specific, single-purpose

IC: Full-custom, semi-custom, PLD

Design: Compilation/synthesis, libraries/IP, test/verification

